504724237 01/11/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MATSUO YOSHIHIRO	01/11/2018

RECEIVING PARTY DATA

Name:	SUMITOMO BAKELITE CO., LTD.
Street Address:	TENNOZ PARKSIDE BUILDING
Internal Address:	5-8 HIGASHI-SHINAGAWA 2-CHOME
City:	SHINAGAWA-KU, TOKYO
State/Country:	JAPAN
Postal Code:	140-0002

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15041070

CORRESPONDENCE DATA

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Email: balu.gupta@promerus.com

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ATTORNEY DOCKET NUMBER:	D15-001US
NAME OF SUBMITTER:	BALARAM GUPTA
SIGNATURE:	/Balaram Gupta/
DATE SIGNED:	01/11/2018

Total Attachments: 2

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PATENT 504724237 REEL: 045042 FRAME: 0839

Docket No.: D15-001US

ASSIGNMENT

WHEREAS, as a below named inventor, I have invented certain new and useful improvements in

Cured Phenolic Spheres and Method of Producing the Same (Invention Title)

	for which I have this day executed an application for a United States Patent (hereinafter "said application").
and/	or
\boxtimes	for which an application for a United States Patent was filed on <u>02/11/2016</u> (mm/dd/yyyy) bearing Application Number <u>15/041.070</u> (hereinafter "said application").
and/	$oldsymbol{x}$
	for which an international patent application was filed under the Patent Cooperation Treaty on(mm/dd/yyyy) bearing Application Number (hereinafter "said application").

AND, WHEREAS, Sumitomo Bakelite Co., Ltd., having a place of business at Tennoz Parkside Building, 5-8 Higashi-Shinagawa 2-chome, Shinagawa-ku, Tokyo 140-0002, Japan, hereinafter called the "Assignee," is desirous of acquiring the entire right, title, and interest in and to said application and the inventions and improvements therein disclosed.

NOW, THEREFORE, for good and valuable consideration paid to me by said assignee, the receipt of which is hereby acknowledged, I as the inventor or as one of the inventors, hereinafter the assignor(s), do hereby assign, sell and transfer unto said assignee the full and exclusive right, title and interest in and to said application and the inventions and improvements therein disclosed for the United States and all foreign countries and any Letters Patent which may issue therefor in the United States and all foreign countries and all divisionals, reissues, continuations, continuations-in-part, renewals and/or extensions thereof. Such assignment extends to the full ends of the terms of these applications and patents as fully and entirely as the same would have been held and enjoyed by me had this Assignment not been made.

I covenant that I am the lawful owner(s) of said application, inventions and improvements that the same are unencumbered, that no license has been granted to make, use or vend the said inventions or improvements or any of them, and that I have the full right to make this Assignment.

And for the consideration aforesaid, I agree individually and, if applicable, jointly that I will communicate to said assignee or the representatives thereof any facts known to me respecting said inventions and improvements, and will, upon request but without expense to me, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, continuation-in-part, renewal and/or extension applications, make all rightful oaths, and generally do all other and further lawful acts deemed necessary or expedient by said assignee or by counsel for said assignee to assist or enable said assignee to obtain and enforce full benefits from the rights and interests herein assigned. This Assignment shall be binding upon my heirs, executors, administrators and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors and/or assigns, as the case may be, of said assignee.

Docket No.: D15-091US

1. FULL NAME OF ASSIGNOR:

MATSUO YOSHIHIRO

RESIDENCE:

c/o SUMITOMO BAKELITE CO., LTD. TENNOZ PARKSIDE BUILDING 5-8 HIGASHI-SHINAGAWA 2-CHOME SHINAGAWA-KU TOKYO 140-0002, JAPAN

EXECUTED this // day of January 2018

SIGNATURE

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